

### 1.6X0.8mm SMD CHIP LED LAMP

Part Number: APT1608ZGC/E

Green



**ATTENTION** OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** 

DISCHARGE SENSITIVE **DEVICES** 

#### **Features**

- 1.6mmX0.8mm SMT LED, 0.75mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel .
- Moisture sensitivity level : level 3.
- RoHS compliant.

### Description

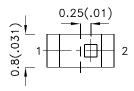
The Green source color devices are made with InGaN Light Emitting Diode.

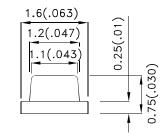
Static electricity and surge damage the LEDS.

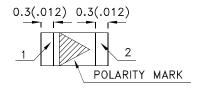
It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

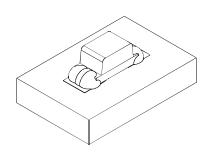
# **Package Dimensions**











- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1(0.004")$  unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

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## **Selection Guide**

| Part No.     | Dice          | Lens Type   | lv (mcd) [2]<br>@ 20mA |      | Viewing<br>Angle [1] |
|--------------|---------------|-------------|------------------------|------|----------------------|
|              |               | ,           | Min.                   | Тур. | 201/2                |
| APT1608ZGC/E | Green (InGaN) | WATER CLEAR | 280                    | 650  | 120°                 |

#### Notes

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- 2. Luminous intensity/ luminous Flux: +/-15%.

# Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter                | Device | Тур. | Max. | Units | Test Conditions    |
|--------|--------------------------|--------|------|------|-------|--------------------|
| λpeak  | Peak Wavelength          | Green  | 520  |      | nm    | IF=20mA            |
| λD [1] | Dominant Wavelength      | Green  | 525  |      | nm    | IF=20mA            |
| Δλ1/2  | Spectral Line Half-width | Green  | 35   |      | nm    | IF=20mA            |
| С      | Capacitance              | Green  | 100  |      | pF    | VF=0V;f=1MHz       |
| VF [2] | Forward Voltage          | Green  | 3.2  | 4    | V     | IF=20mA            |
| lR     | Reverse Current          | Green  |      | 10   | uA    | V <sub>R</sub> =5V |

#### Notes:

- 1.Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.

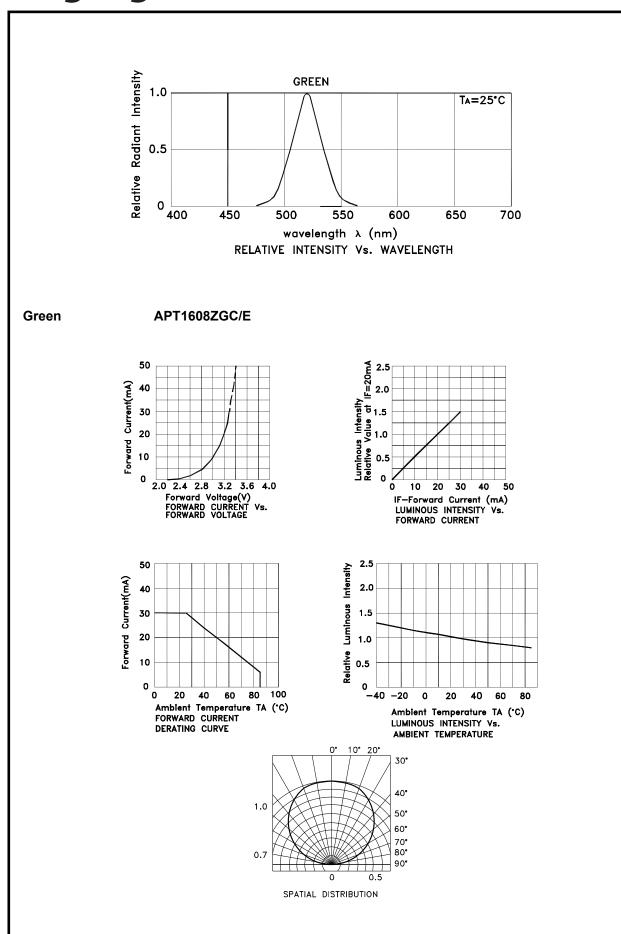
### Absolute Maximum Ratings at TA=25°C

| Parameter                | Green          | Units |  |  |
|--------------------------|----------------|-------|--|--|
| Power dissipation        | 120            | mW    |  |  |
| DC Forward Current       | 30             | mA    |  |  |
| Peak Forward Current [1] | 100            | mA    |  |  |
| Reverse Voltage          | 5              | V     |  |  |
| Operating Temperature    | -40°C To +85°C |       |  |  |
| Storage Temperature      | -40°C To +85°C |       |  |  |

#### Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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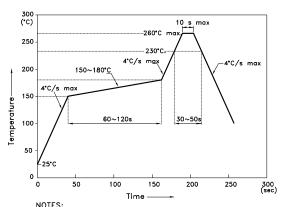
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### APT1608ZGC/E

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



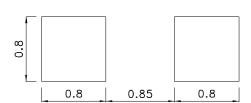
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

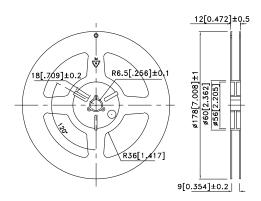
  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- to high temperature.

  3.Number of reflow process shall be 2 times or less.

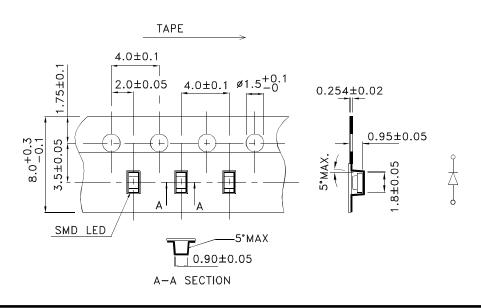
# Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



## **Reel Dimension**

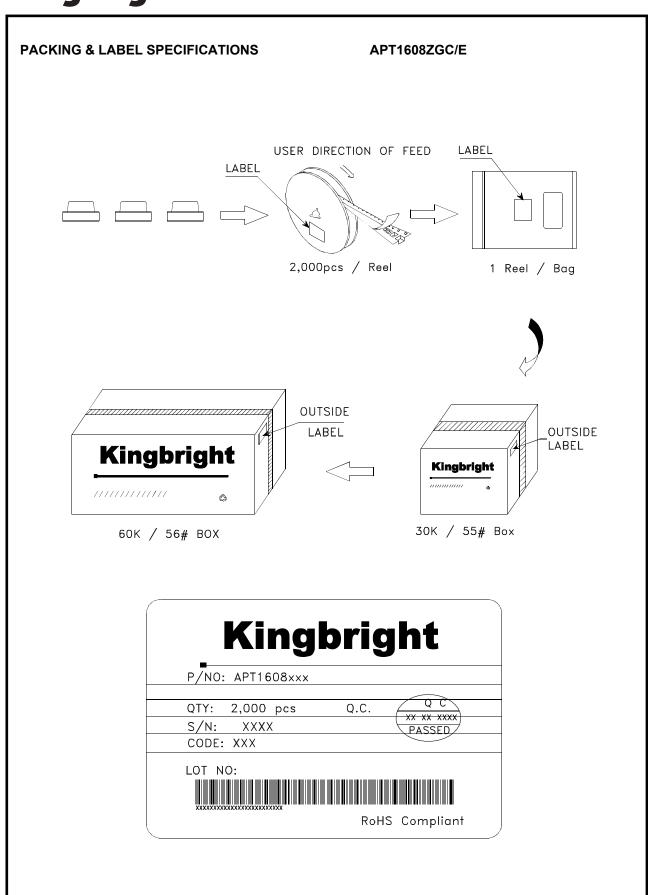


Tape Dimensions (Units : mm)



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